

# LIGHT ELECTRONICS CO., LTD. Part No. LG-355PT2C94F-928 4 of 9 Page





## Photo Transistor Diode Specification

- ●Commodity: Photo Transistor
  - ●Ic(on) Bin Code (V<sub>CE</sub>=5V, Ee=1mW/cm²

BIN CODE	Min. (mA)	Max. (mA)
X2	3.7	4.4

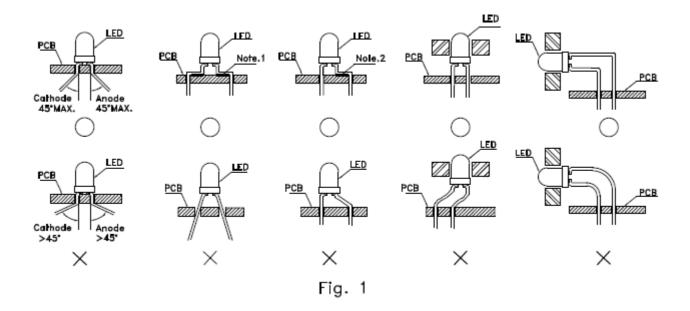






### LED MOUNTING METHOD

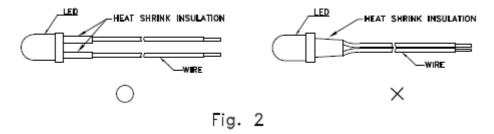
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).



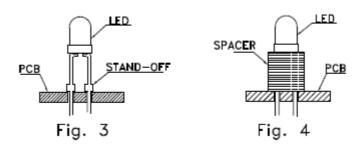
" " Correct mounting method "x" Incorrect mounting method

Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

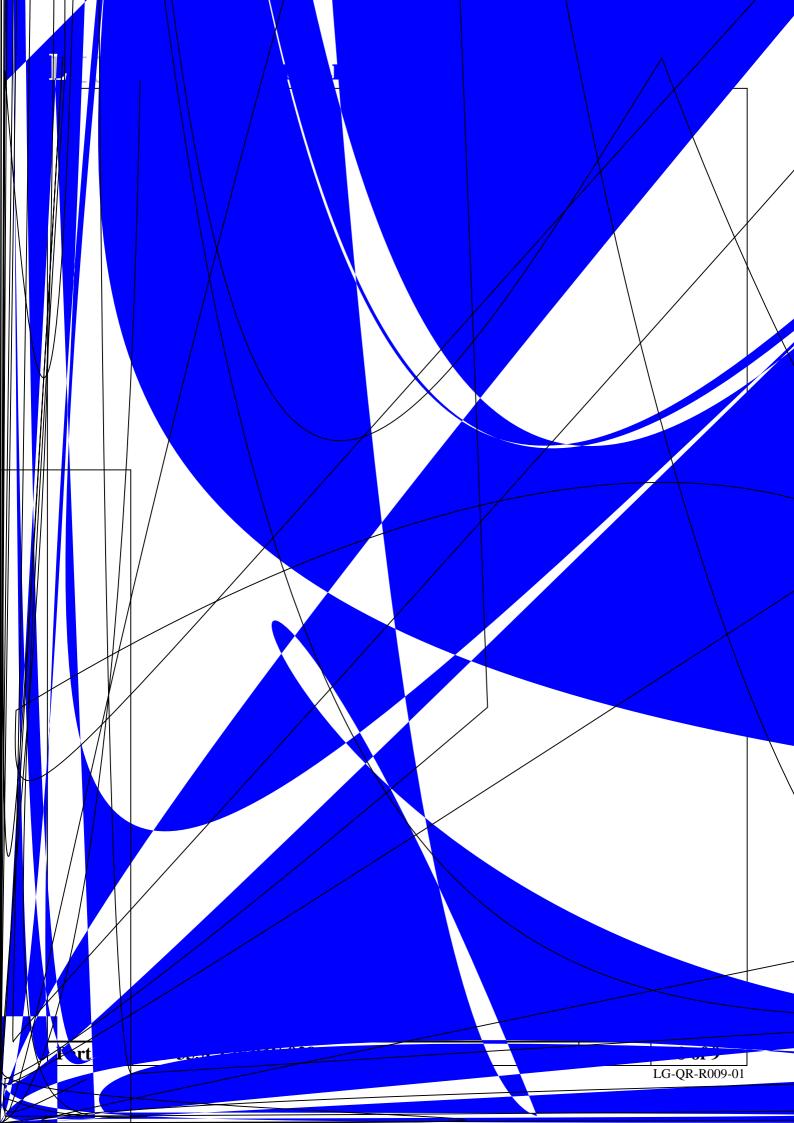
2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).



3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.

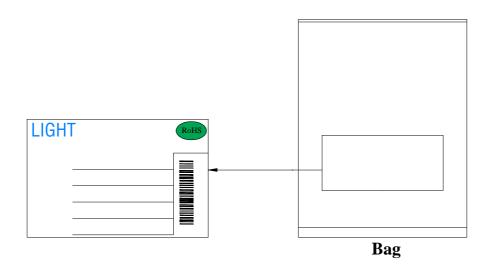


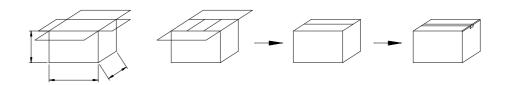
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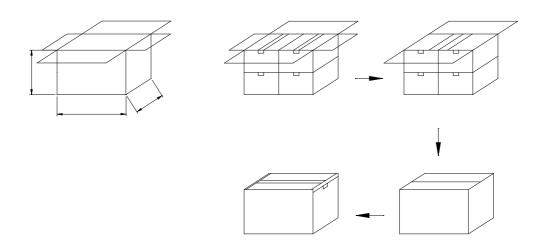




### PACKAGE







Bag minimum volume	Bag volume	Inner box volume	Outer carton volume
(pcs / Bag)	(pcs / Bag)	(Bag / box)	(Box / Carton)
500	1000	10	4

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